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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	3584
Number of Logic Elements/Cells	-
Total RAM Bits	1769472
Number of I/O	720
Number of Gates	3000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v3000-6ffg1152c

Each SelectRAM memory and multiplier block is tied to four switch matrices, as shown in [Figure 35](#).

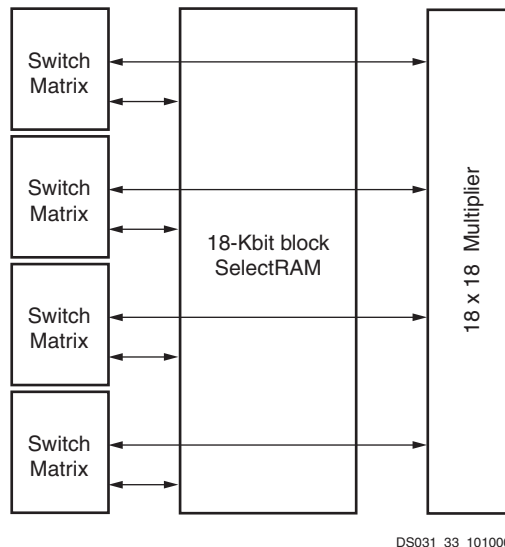


Figure 35: SelectRAM and Multiplier Blocks

Association With Block SelectRAM Memory

The interconnect is designed to allow SelectRAM memory and multiplier blocks to be used at the same time, but some interconnect is shared between the SelectRAM and the multiplier. Thus, SelectRAM memory can be used only up to 18 bits wide when the multiplier is used, because the multiplier shares inputs with the upper data bits of the SelectRAM memory.

This sharing of the interconnect is optimized for an 18-bit-wide block SelectRAM resource feeding the multiplier. The use of SelectRAM memory and the multiplier with an accumulator in LUTs allows for implementation of a digital signal processor (DSP) multiplier-accumulator (MAC) function, which is commonly used in finite and infinite impulse response (FIR and IIR) digital filters.

Configuration

The multiplier block is an 18-bit by 18-bit signed multiplier (2's complement). Both A and B are 18-bit-wide inputs, and the output is 36 bits. [Figure 36](#) shows a multiplier block.

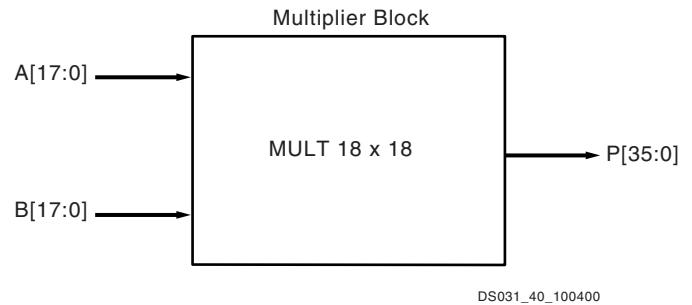


Figure 36: Multiplier Block

Locations / Organization

Multiplier organization is identical to the 18 Kbit SelectRAM organization, because each multiplier is associated with an 18 Kbit block SelectRAM resource.

In addition to the built-in multiplier blocks, the CLB elements have dedicated logic to implement efficient multipliers in logic. (Refer to [Configurable Logic Blocks \(CLBs\)](#)).

Table 20: Multiplier Floor Plan

Device	Columns	Multipliers	
		Per Column	Total
XC2V40	2	2	4
XC2V80	2	4	8
XC2V250	4	6	24
XC2V500	4	8	32
XC2V1000	4	10	40
XC2V1500	4	12	48
XC2V2000	4	14	56
XC2V3000	6	16	96
XC2V4000	6	20	120
XC2V6000	6	24	144
XC2V8000	6	28	168

Virtex-II Electrical Characteristics

Virtex-II™ devices are provided in -6, -5, and -4 speed grades, with -6 having the highest performance.

Virtex-II DC and AC characteristics are specified for both commercial and industrial grades. Except the operating temperature range or unless otherwise noted, all the DC and AC electrical parameters are the same for a particular speed grade (that is, the timing characteristics of a -4 speed grade industrial device are the same as for a -4 speed grade

commercial device). However, only selected speed grades and/or devices might be available in the industrial range.

All supply voltage and junction temperature specifications are representative of worst-case conditions. The parameters included are common to popular designs and typical applications. Contact Xilinx for design considerations requiring more detailed information.

All specifications are subject to change without notice.

Virtex-II DC Characteristics

Table 1: Absolute Maximum Ratings

Symbol	Description ⁽¹⁾			Units
V _{CCINT}	Internal supply voltage relative to GND		−0.5 to 1.65	V
V _{CCAUX}	Auxiliary supply voltage relative to GND		−0.5 to 4.0	V
V _{CCO}	Output drivers supply voltage relative to GND		−0.5 to 4.0	V
V _{BATT}	Key memory battery backup supply		−0.5 to 4.0	V
V _{REF}	Input reference voltage		−0.5 to V _{CCO} + 0.5	V
V _{IN} ⁽³⁾	Input voltage relative to GND (user and dedicated I/Os)		−0.5 to V _{CCO} + 0.5	V
V _{TS}	Voltage applied to 3-state output (user and dedicated I/Os)		−0.5 to 4.0	V
T _{STG}	Storage temperature (ambient)		−65 to +150	°C
T _{SOL}	Maximum soldering temperature ⁽²⁾	All regular FF/BF flip-chip and FG/BG/CS wire-bond packages	+220	°C
		Pb-free FGG456, FGG676, BGG575, and BGG728 wire-bond packages	+250	°C
		Pb-free FGG256 and CSG144 wire-bond packages	+260	°C
T _J	Maximum junction temperature ⁽²⁾		+125	°C

Notes:

- Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.
- For soldering guidelines and thermal considerations, see the [Device Packaging and Thermal Characteristics Guide](#) information on the Xilinx website.
- Inputs configured as PCI are fully PCI compliant. This statement takes precedence over any specification that would imply that the device is not PCI compliant.

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
HSTL, Class II, 1.8V	HSTL_II_18	T _{OHSTL_II_18}	-0.17	-0.18	-0.20	ns
HSTL, Class III, 1.8V	HSTL_III_18	T _{OHSTL_III_18}	-0.16	-0.16	-0.18	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	T _{OHSTL_IV_18}	-0.39	-0.40	-0.44	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	T _{OSSTL18_I}	0.20	0.20	0.22	ns
SSTL, Class II, 1.8V	SSTL18_II	T _{OSSTL18_II}	-0.05	-0.05	-0.06	ns
SSTL, Class I, 2.5V	SSTL2_I	T _{OSSTL2_I}	0.21	0.22	0.24	ns
SSTL, Class II, 2.5V	SSTL2_II	T _{OSSTL2_II}	-0.15	-0.16	-0.18	ns
SSTL, Class I, 3.3V	SSTL3_I	T _{OSSTL3_I}	0.29	0.30	0.33	ns
SSTL, Class II, 3.3V	SSTL3_II	T _{OSSTL3_II}	-0.05	-0.05	-0.05	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	T _{OAGP}	-0.27	-0.28	-0.31	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T _{OLVDCI_33}	0.74	0.77	0.84	ns
LVDCI, 2.5V	LVDCI_25	T _{OLVDCI_25}	0.78	0.80	0.88	ns
LVDCI, 1.8V	LVDCI_18	T _{OLVDCI_18}	0.84	0.87	0.95	ns
LVDCI, 1.5V	LVDCI_15	T _{OLVDCI_15}	1.82	1.88	2.06	ns
LVDCI, 3.3V, Half-Impedance	LVDCI_DV2_33	T _{OLVDCI_DV2_33}	0.12	0.12	0.13	ns
LVDCI, 2.5V, Half-Impedance	LVDCI_DV2_25	T _{OLVDCI_DV2_25}	0.03	0.03	0.03	ns
LVDCI, 1.8V, Half-Impedance	LVDCI_DV2_18	T _{OLVDCI_DV2_18}	0.42	0.43	0.48	ns
LVDCI, 1.5V, Half-Impedance	LVDCI_DV2_15	T _{OLVDCI_DV2_15}	1.20	1.23	1.36	ns
HSLVDCI (High-Speed Low-Voltage DCI), 1.5V	HSLVDCI_15	T _{OHSLVDCI_15}	1.82	1.88	2.06	ns
HSLVDCI, 1.8V	HSLVDCI_18	T _{OHSLVDCI_18}	1.05	1.08	1.24	ns
HSLVDCI, 2.5V	HSLVDCI_25	T _{OHSLVDCI_25}	0.78	0.80	0.88	ns
HSLVDCI, 3.3V	HSLVDCI_33	T _{OHSLVDCI_33}	0.74	0.77	0.84	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T _{OGTL_DCI}	-0.31	-0.32	-0.35	ns
GTL Plus with DCI	GTL_P_DCI	T _{OGTL_P_DCI}	-0.15	-0.16	-0.17	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	T _{OHSTL_I_DCI}	0.23	0.23	0.26	ns
HSTL, Class II, with DCI	HSTL_II_DCI	T _{OHSTL_II_DCI}	0.06	0.06	0.07	ns
HSTL, Class III, with DCI	HSTL_III_DCI	T _{OHSTL_III_DCI}	-0.17	-0.18	-0.20	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	T _{OHSTL_IV_DCI}	-0.46	-0.47	-0.52	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	T _{OHSTL_I_DCI_18}	0.05	0.05	0.06	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	T _{OHSTL_II_DCI_18}	-0.03	-0.03	-0.03	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	T _{OHSTL_III_DCI_18}	-0.14	-0.14	-0.16	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	T _{OHSTL_IV_DCI_18}	-0.41	-0.42	-0.47	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	T _{OSSTL18_I_DCI}	0.36	0.37	0.40	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	T _{OSSTL18_II_DCI}	0.06	0.06	0.07	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	T _{OSSTL2_I_DCI}	0.12	0.13	0.14	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	T _{OSSTL2_II_DCI}	-0.10	-0.10	-0.11	ns
SSTL, Class I, 3.3V, with DCI	SSTL3_I_DCI	T _{OSSTL3_I_DCI}	0.15	0.16	0.17	ns
SSTL, Class II, 3.3V, with DCI	SSTL3_II_DCI	T _{OSSTL3_II_DCI}	0.08	0.08	0.09	ns

FG256/FGG256 Fine-Pitch BGA Package

As shown in Table 6, XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000 Virtex-II devices are available in the FG256/FGG256 fine-pitch BGA package. The pins in the XC2V250, XC2V500, and XC2V1000 devices are same. The No Connect columns show pin differences for the XC2V40 and XC2V80 devices. Following this table are the **FG256/FGG256 Fine-Pitch BGA Package Specifications (1.00mm pitch)**.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
0	IO_L01N_0	C4		
0	IO_L01P_0	B4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	B5		
0	IO_L03P_0/VRN_0	A5		
0	IO_L04N_0/VREF_0	D6	NC	NC
0	IO_L04P_0	C6	NC	NC
0	IO_L05N_0	B6	NC	NC
0	IO_L05P_0	A6	NC	NC
0	IO_L92N_0	E6	NC	NC
0	IO_L92P_0	E7	NC	NC
0	IO_L93N_0	D7	NC	NC
0	IO_L93P_0	C7	NC	NC
0	IO_L94N_0/VREF_0	B7		
0	IO_L94P_0	A7		
0	IO_L95N_0/GCLK7P	D8		
0	IO_L95P_0/GCLK6S	C8		
0	IO_L96N_0/GCLK5P	B8		
0	IO_L96P_0/GCLK4S	A8		
1	IO_L96N_1/GCLK3P	A9		
1	IO_L96P_1/GCLK2S	B9		
1	IO_L95N_1/GCLK1P	C9		
1	IO_L95P_1/GCLK0S	D9		
1	IO_L94N_1	A10		
1	IO_L94P_1/VREF_1	B10		
1	IO_L93N_1	C10	NC	NC
1	IO_L93P_1	D10	NC	NC
1	IO_L92N_1	E10	NC	NC

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
0	VCCO_0	F7		
1	VCCO_1	G14		
1	VCCO_1	G13		
1	VCCO_1	G12		
1	VCCO_1	F16		
1	VCCO_1	F15		
2	VCCO_2	L16		
2	VCCO_2	K16		
2	VCCO_2	J16		
2	VCCO_2	H17		
2	VCCO_2	G17		
3	VCCO_3	T17		
3	VCCO_3	R17		
3	VCCO_3	P16		
3	VCCO_3	N16		
3	VCCO_3	M16		
4	VCCO_4	U16		
4	VCCO_4	U15		
4	VCCO_4	T14		
4	VCCO_4	T13		
4	VCCO_4	T12		
5	VCCO_5	U8		
5	VCCO_5	U7		
5	VCCO_5	T11		
5	VCCO_5	T10		
5	VCCO_5	T9		
6	VCCO_6	T6		
6	VCCO_6	R6		
6	VCCO_6	P7		
6	VCCO_6	N7		
6	VCCO_6	M7		
7	VCCO_7	L7		
7	VCCO_7	K7		
7	VCCO_7	J7		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
4	IO_L06P_4	Y21		
4	IO_L19N_4	AE24		
4	IO_L19P_4	AF24		
4	IO_L21N_4	AE23		
4	IO_L21P_4/VREF_4	AF23		
4	IO_L22N_4	AE22		
4	IO_L22P_4	AF22		
4	IO_L24N_4	AF21		
4	IO_L24P_4	AF20		
4	IO_L25N_4	AA19	NC	NC
4	IO_L25P_4	AB19	NC	NC
4	IO_L27N_4	AD20	NC	NC
4	IO_L27P_4/VREF_4	AC20	NC	NC
4	IO_L28N_4	AC19	NC	NC
4	IO_L28P_4	AD19	NC	NC
4	IO_L49N_4	AE19		
4	IO_L49P_4	AF19		
4	IO_L51N_4	AA18		
4	IO_L51P_4/VREF_4	AB18		
4	IO_L52N_4	Y18		
4	IO_L52P_4	Y17		
4	IO_L54N_4	AC18		
4	IO_L54P_4	AD18		
4	IO_L67N_4	AE18		
4	IO_L67P_4	AF18		
4	IO_L69N_4	AA17		
4	IO_L69P_4/VREF_4	AB17		
4	IO_L70N_4	AC17		
4	IO_L70P_4	AD17		
4	IO_L72N_4	AF17		
4	IO_L72P_4	AF16		
4	IO_L73N_4	AB16	NC	
4	IO_L73P_4	AC16	NC	
4	IO_L75N_4	AA16	NC	
4	IO_L75P_4/VREF_4	Y16	NC	
4	IO_L76N_4	AD16	NC	
4	IO_L76P_4	AE16	NC	

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
5	IO_L70N_5	W11		
5	IO_L70P_5	Y10		
5	IO_L69N_5/VREF_5	Y11		
5	IO_L69P_5	AA11		
5	IO_L67N_5	AF9		
5	IO_L67P_5	AF8		
5	IO_L54N_5	AE9		
5	IO_L54P_5	AD9		
5	IO_L52N_5	AB10		
5	IO_L52P_5	AA10		
5	IO_L51N_5/VREF_5	AD10		
5	IO_L51P_5	AC10		
5	IO_L49N_5	AE8		
5	IO_L49P_5	AF7		
5	IO_L28N_5	AD8	NC	NC
5	IO_L28P_5	AC8	NC	NC
5	IO_L27N_5/VREF_5	AB9	NC	NC
5	IO_L27P_5	AC9	NC	NC
5	IO_L25N_5	AA9	NC	NC
5	IO_L25P_5	Y9	NC	NC
5	IO_L24N_5	AF6		
5	IO_L24P_5	AE6		
5	IO_L22N_5	AB8		
5	IO_L22P_5	AA8		
5	IO_L21N_5/VREF_5	AC7		
5	IO_L21P_5	AD7		
5	IO_L19N_5	AF5		
5	IO_L19P_5	AE5		
5	IO_L06N_5	AF4		
5	IO_L06P_5	AE4		
5	IO_L05N_5/VRP_5	AF3		
5	IO_L05P_5/VRN_5	AE3		
5	IO_L04N_5	Y8		
5	IO_L04P_5/VREF_5	Y7		
5	IO_L03N_5/D4/ALT_VRP_5	AB7		
5	IO_L03P_5/D5/ALT_VRN_5	AA7		
5	IO_L02N_5/D6	AD6		

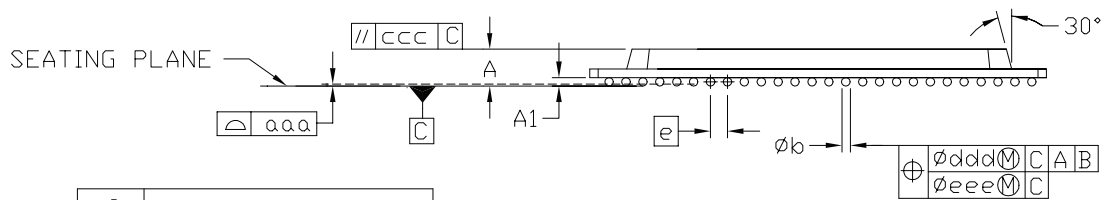
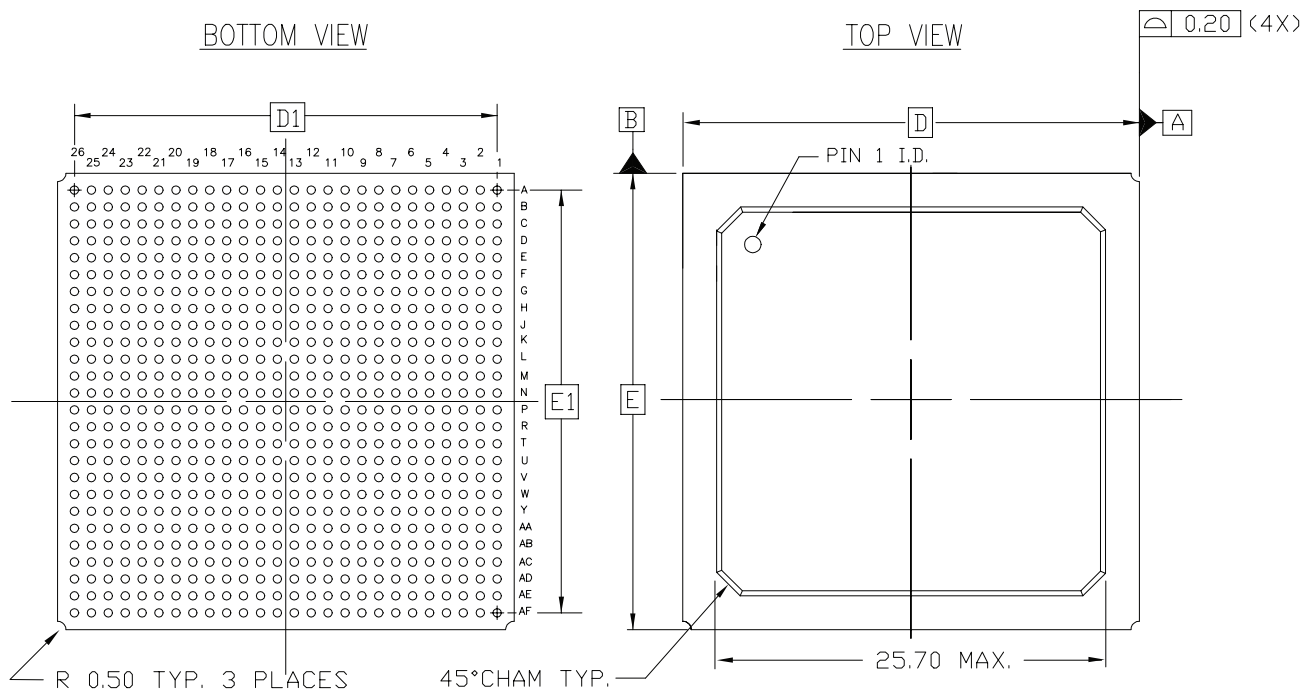
Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L78N_7	M2	NC	
7	IO_L76P_7	M5	NC	
7	IO_L76N_7	M6	NC	
7	IO_L75P_7/VREF_7	M3	NC	
7	IO_L75N_7	M4	NC	
7	IO_L73P_7	M7	NC	
7	IO_L73N_7	M8	NC	
7	IO_L72P_7	L1		
7	IO_L72N_7	L2		
7	IO_L70P_7	L5		
7	IO_L70N_7	L6		
7	IO_L69P_7/VREF_7	L3		
7	IO_L69N_7	L4		
7	IO_L67P_7	K1		
7	IO_L67N_7	J1		
7	IO_L54P_7	K3		
7	IO_L54N_7	K4		
7	IO_L52P_7	K5		
7	IO_L52N_7	K6		
7	IO_L51P_7/VREF_7	L8		
7	IO_L51N_7	L7		
7	IO_L49P_7	J2		
7	IO_L49N_7	H1		
7	IO_L48P_7	J3		
7	IO_L48N_7	J4		
7	IO_L46P_7	J5		
7	IO_L46N_7	J6		
7	IO_L45P_7/VREF_7	H5		
7	IO_L45N_7	H4		
7	IO_L43P_7	K7		
7	IO_L43N_7	J7		
7	IO_L25P_7	H2	NC	NC
7	IO_L25N_7	H3	NC	NC
7	IO_L24P_7	G1		
7	IO_L24N_7	F1		
7	IO_L22P_7	G3		
7	IO_L22N_7	G4		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	VCCINT	H19		
NA	VCCINT	H8		
NA	GND	AF26		
NA	GND	AF1		
NA	GND	AE25		
NA	GND	AE14		
NA	GND	AE13		
NA	GND	AE2		
NA	GND	AD24		
NA	GND	AD3		
NA	GND	AC23		
NA	GND	AC4		
NA	GND	AB22		
NA	GND	AB5		
NA	GND	AA21		
NA	GND	AA6		
NA	GND	U17		
NA	GND	U16		
NA	GND	U15		
NA	GND	U14		
NA	GND	U13		
NA	GND	U12		
NA	GND	U11		
NA	GND	U10		
NA	GND	T17		
NA	GND	T16		
NA	GND	T15		
NA	GND	T14		
NA	GND	T13		
NA	GND	T12		
NA	GND	T11		
NA	GND	T10		
NA	GND	R17		
NA	GND	R16		
NA	GND	R15		
NA	GND	R14		
NA	GND	R13		

FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch)



FG676 - 63/37 (Sn/Pb) Solder Balls
FGG676 - Sn/Ag/Cu Solder Balls

SYMBOL	MILLIMETERS		
	MIN.	NOM.	MAX.
A	$\sim$	2.25	2.60
A ₁	0.40	0.50	0.60
D/E	27.00 BSC		
D ₁ /E ₁	25.00 REF		
e	1.00 BSC		
øb	0.50	0.60	0.70
aaa	$\sim$	$\sim$	0.20
ccc	$\sim$	$\sim$	0.35
ddd	$\sim$	$\sim$	0.30
eee	$\sim$	$\sim$	0.10
M	26		

NOTES:

- ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
- SYMBOL 'M' IS THE BALL MATRIX SIZE.
- CONFORMS TO JEDEC MS-034-AAL-1

676-BALL FINE PITCH BGA (FG676/FGG676)

Figure 4: FG676/FGG676 Fine-Pitch BGA Package Specifications

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
0	IO_L52P_0	E10
0	IO_L54N_0	D10
0	IO_L54P_0	C10
0	IO_L67N_0	B10
0	IO_L67P_0	A10
0	IO_L69N_0	G11
0	IO_L69P_0/VREF_0	H11
0	IO_L70N_0	F11
0	IO_L70P_0	F12
0	IO_L72N_0	D11
0	IO_L72P_0	C11
0	IO_L73N_0	B11
0	IO_L73P_0	A11
0	IO_L75N_0	H12
0	IO_L75P_0/VREF_0	J12
0	IO_L76N_0	E12
0	IO_L76P_0	D12
0	IO_L78N_0	B12
0	IO_L78P_0	A12
0	IO_L91N_0/VREF_0	J13
0	IO_L91P_0	H13
0	IO_L92N_0	G13
0	IO_L92P_0	F13
0	IO_L93N_0	E13
0	IO_L93P_0	D13
0	IO_L94N_0/VREF_0	B13
0	IO_L94P_0	A13
0	IO_L95N_0/GCLK7P	C13
0	IO_L95P_0/GCLK6S	C14
0	IO_L96N_0/GCLK5P	F14
0	IO_L96P_0/GCLK4S	E14
1	IO_L96N_1/GCLK3P	G14
1	IO_L96P_1/GCLK2S	H14
1	IO_L95N_1/GCLK1P	A15
1	IO_L95P_1/GCLK0S	B15

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
3	IO_L19N_3	AB26
3	IO_L19P_3	AB25
3	IO_L06N_3	AB24
3	IO_L06P_3	AB23
3	IO_L04N_3	AC27
3	IO_L04P_3	AC26
3	IO_L03N_3/VREF_3	AC25
3	IO_L03P_3	AC24
3	IO_L02N_3/VRP_3	AD27
3	IO_L02P_3/VRN_3	AE27
3	IO_L01N_3	AD26
3	IO_L01P_3	AD25
4	IO_L01N_4/BUSY/DOOUT ⁽¹⁾	AF25
4	IO_L01P_4/INIT_B	AG25
4	IO_L02N_4/D0/DIN ⁽¹⁾	AF24
4	IO_L02P_4/D1	AG24
4	IO_L03N_4/D2/ALT_VRP_4	AD23
4	IO_L03P_4/D3/ALT_VRN_4	AE23
4	IO_L04N_4/VREF_4	AF23
4	IO_L04P_4	AG23
4	IO_L05N_4/VRP_4	AD22
4	IO_L05P_4/VRN_4	AE22
4	IO_L06N_4	AF22
4	IO_L06P_4	AG22
4	IO_L19N_4	AC21
4	IO_L19P_4	AB21
4	IO_L21N_4	AE21
4	IO_L21P_4/VREF_4	AE20
4	IO_L22N_4	AF21
4	IO_L22P_4	AG21
4	IO_L24N_4	AB20
4	IO_L24P_4	AA20
4	IO_L25N_4	AC20
4	IO_L25P_4	AD20
4	IO_L27N_4	AG20

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
7	IO_L95N_7	R24		
7	IO_L94P_7	R29		
7	IO_L94N_7	T29		
7	IO_L93P_7/VREF_7	R27		
7	IO_L93N_7	P27		
7	IO_L92P_7	R23		
7	IO_L92N_7	P23		
7	IO_L91P_7	N30		
7	IO_L91N_7	P30		
7	IO_L78P_7	P26	NC	NC
7	IO_L78N_7	R26	NC	NC
7	IO_L77P_7	R22	NC	NC
7	IO_L77N_7	P22	NC	NC
7	IO_L76P_7	N29	NC	NC
7	IO_L76N_7	P29	NC	NC
7	IO_L75P_7/VREF_7	N27	NC	NC
7	IO_L75N_7	N26	NC	NC
7	IO_L74P_7	P25	NC	NC
7	IO_L74N_7	N25	NC	NC
7	IO_L73P_7	L30	NC	NC
7	IO_L73N_7	M30	NC	NC
7	IO_L72P_7	L28	NC	
7	IO_L72N_7	M28	NC	
7	IO_L71P_7	N24	NC	
7	IO_L71N_7	M24	NC	
7	IO_L70P_7	L29	NC	
7	IO_L70N_7	M29	NC	
7	IO_L69P_7/VREF_7	M27	NC	
7	IO_L69N_7	L27	NC	
7	IO_L68P_7	N23	NC	
7	IO_L68N_7	M23	NC	
7	IO_L67P_7	J30	NC	
7	IO_L67N_7	K30	NC	
7	IO_L54P_7	K26		
7	IO_L54N_7	L26		
7	IO_L53P_7	M25		
7	IO_L53N_7	L25		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	M5		
NA	GND	K28		
NA	GND	K3		
NA	GND	H30		
NA	GND	H1		
NA	GND	G17		
NA	GND	G14		
NA	GND	F25		
NA	GND	F6		
NA	GND	E26		
NA	GND	E19		
NA	GND	E12		
NA	GND	E5		
NA	GND	D27		
NA	GND	D4		
NA	GND	C28		
NA	GND	C21		
NA	GND	C10		
NA	GND	C3		
NA	GND	B29		
NA	GND	B2		
NA	GND	A23		
NA	GND	A8		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L21N_2	H7	
2	IO_L21P_2/VREF_2	J7	
2	IO_L22N_2	H6	
2	IO_L22P_2	G6	
2	IO_L23N_2	L10	
2	IO_L23P_2	L9	
2	IO_L24N_2	G3	
2	IO_L24P_2	F3	
2	IO_L25N_2	G2	
2	IO_L25P_2	F2	
2	IO_L26N_2	M10	
2	IO_L26P_2	N10	
2	IO_L27N_2	J6	
2	IO_L27P_2/VREF_2	K6	
2	IO_L28N_2	J5	
2	IO_L28P_2	H5	
2	IO_L29N_2	L7	
2	IO_L29P_2	K7	
2	IO_L30N_2	J4	
2	IO_L30P_2	H4	
2	IO_L43N_2	G1	
2	IO_L43P_2	F1	
2	IO_L44N_2	L8	
2	IO_L44P_2	M8	
2	IO_L45N_2	J1	
2	IO_L45P_2/VREF_2	H2	
2	IO_L46N_2	J3	
2	IO_L46P_2	H3	
2	IO_L47N_2	M9	
2	IO_L47P_2	N9	
2	IO_L48N_2	L5	
2	IO_L48P_2	K5	
2	IO_L49N_2	K2	
2	IO_L49P_2	J2	
2	IO_L50N_2	N7	
2	IO_L50P_2	M7	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
4	IO_L91N_4/VREF_4	AL16	
4	IO_L91P_4	AL17	
4	IO_L92N_4	AJ17	
4	IO_L92P_4	AJ16	
4	IO_L93N_4	AM15	
4	IO_L93P_4	AM14	
4	IO_L94N_4/VREF_4	AM16	
4	IO_L94P_4	AM17	
4	IO_L95N_4/GCLK3S	AF17	
4	IO_L95P_4/GCLK2P	AG17	
4	IO_L96N_4/GCLK1S	AK16	
4	IO_L96P_4/GCLK0P	AK17	
5	IO_L96N_5/GCLK7S	AK18	
5	IO_L96P_5/GCLK6P	AK19	
5	IO_L95N_5/GCLK5S	AG18	
5	IO_L95P_5/GCLK4P	AF18	
5	IO_L94N_5	AL18	
5	IO_L94P_5/VREF_5	AL19	
5	IO_L93N_5	AJ19	
5	IO_L93P_5	AJ18	
5	IO_L92N_5	AH19	
5	IO_L92P_5	AH18	
5	IO_L91N_5	AM19	
5	IO_L91P_5/VREF_5	AM20	
5	IO_L84N_5	AL21	NC
5	IO_L84P_5	AL20	NC
5	IO_L83N_5	AM22	NC
5	IO_L83P_5	AM21	NC
5	IO_L82N_5	AN18	NC
5	IO_L82P_5	AP18	NC
5	IO_L81N_5/VREF_5	AP20	NC
5	IO_L81P_5	AN19	NC
5	IO_L80N_5	AE18	NC
5	IO_L80P_5	AE19	NC
5	IO_L79N_5	AP22	NC

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
4	IO_L78N_4	AJ13	
4	IO_L78P_4	AK13	
4	IO_L91N_4/VREF_4	AC15	
4	IO_L91P_4	AC16	
4	IO_L92N_4	AG14	
4	IO_L92P_4	AG15	
4	IO_L93N_4	AK14	
4	IO_L93P_4	AK15	
4	IO_L94N_4/VREF_4	AF16	
4	IO_L94P_4	AG16	
4	IO_L95N_4/GCLK3S	AL14	
4	IO_L95P_4/GCLK2P	AL15	
4	IO_L96N_4/GCLK1S	AH15	
4	IO_L96P_4/GCLK0P	AJ15	
5	IO_L96N_5/GCLK7S	AJ16	
5	IO_L96P_5/GCLK6P	AH17	
5	IO_L95N_5/GCLK5S	AD16	
5	IO_L95P_5/GCLK4P	AD17	
5	IO_L94N_5	AL17	
5	IO_L94P_5/VREF_5	AL18	
5	IO_L93N_5	AG17	
5	IO_L93P_5	AF17	
5	IO_L92N_5	AE17	
5	IO_L92P_5	AE18	
5	IO_L91N_5	AK17	
5	IO_L91P_5/VREF_5	AJ17	
5	IO_L78N_5	AK18	
5	IO_L78P_5	AK19	
5	IO_L77N_5	AC17	
5	IO_L77P_5	AB18	
5	IO_L76N_5	AH18	
5	IO_L76P_5	AH19	
5	IO_L75N_5/VREF_5	AL19	
5	IO_L75P_5	AL20	
5	IO_L74N_5	AC18	
5	IO_L74P_5	AC19	
5	IO_L73N_5	AJ19	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
6	IO_L20P_6	AD25	
6	IO_L20N_6	AC24	
6	IO_L21P_6	AG30	
6	IO_L21N_6/VREF_6	AF30	
6	IO_L22P_6	AD26	
6	IO_L22N_6	AC26	
6	IO_L23P_6	AF29	
6	IO_L23N_6	AD29	
6	IO_L24P_6	AE28	
6	IO_L24N_6	AD28	
6	IO_L25P_6	AB24	NC
6	IO_L25N_6	AA24	NC
6	IO_L27P_6	AC25	NC
6	IO_L27N_6/VREF_6	AB25	NC
6	IO_L43P_6	AF31	
6	IO_L43N_6	AE31	
6	IO_L44P_6	AA23	
6	IO_L44N_6	Y23	
6	IO_L45P_6	AE30	
6	IO_L45N_6/VREF_6	AC30	
6	IO_L46P_6	AC28	
6	IO_L46N_6	AA28	
6	IO_L47P_6	AD27	
6	IO_L47N_6	AC27	
6	IO_L48P_6	AA25	
6	IO_L48N_6	Y25	
6	IO_L49P_6	AC29	
6	IO_L49N_6	AB29	
6	IO_L50P_6	AB27	
6	IO_L50N_6	AA27	
6	IO_L51P_6	AA26	
6	IO_L51N_6/VREF_6	Y26	
6	IO_L52P_6	AD31	
6	IO_L52N_6	AC31	
6	IO_L53P_6	W22	
6	IO_L53N_6	V22	
6	IO_L54P_6	Y27	
6	IO_L54N_6	W27	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	VCCINT	T21	
NA	VCCINT	U10	
NA	VCCINT	U13	
NA	VCCINT	U19	
NA	VCCINT	U22	
NA	VCCINT	V13	
NA	VCCINT	V19	
NA	VCCINT	W13	
NA	VCCINT	W14	
NA	VCCINT	W15	
NA	VCCINT	W16	
NA	VCCINT	W17	
NA	VCCINT	W18	
NA	VCCINT	W19	
NA	VCCINT	Y12	
NA	VCCINT	Y16	
NA	VCCINT	Y20	
NA	VCCINT	AA11	
NA	VCCINT	AA16	
NA	VCCINT	AA21	
NA	VCCINT	AB15	
NA	VCCINT	AB17	
NA	GND	A2	
NA	GND	A3	
NA	GND	A16	
NA	GND	A29	
NA	GND	A30	
NA	GND	B1	
NA	GND	B2	
NA	GND	B8	
NA	GND	B24	
NA	GND	B30	
NA	GND	B31	
NA	GND	C1	
NA	GND	C3	
NA	GND	C29	
NA	GND	C31	
NA	GND	D4	